

## High resolution structural, chemical and electrical characterization of molybdenum disulfide for next generation field effect transistors

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Transition metal dichalcogenides, such as MoS<sub>2</sub>, recently attracted considerable interest for future electronic and optoelectronic applications [1]. Many recent studies indicated that the basic transport properties (doping, contact resistance,..) of these materials critically depend on the presence of nano- or atomic-scale defects [2,3]. Hence, the combination of high resolution structural/chemical and electrical characterization methods is fundamental to understand and, eventually, modify these electrical properties.

In this work, we show that the Schottky barrier of multilayer MoS<sub>2</sub> surface can be tailored at nanoscale using soft O<sub>2</sub> plasma treatments. The morphological, chemical, and electrical modifications of MoS<sub>2</sub> under different plasma conditions were investigated by several microscopic and spectroscopic techniques, including X-ray photoelectron spectroscopy (XPS), atomic force microscopy (AFM), conductive AFM (CAFM), aberration-corrected scanning transmission electron microscopy (STEM), and electron energy loss spectroscopy (EELS) [4]. Nanoscale current-voltage measurements by CAFM showed that the Schottky barrier height map can be conveniently tuned starting from a narrow distribution (0.2-0.3 eV) in the case of pristine MoS<sub>2</sub> to a broader distribution (0.2-0.8 eV) after O<sub>2</sub> plasma treatment, which allows both electrons and holes injection. This lateral inhomogeneity in the electrical properties was associated with variations of the incorporated oxygen concentration in the MoS<sub>2</sub> multilayer surface, as shown by STEM/EELS analyses and confirmed by ab initio density functional theory (DFT) calculations. Back-gated multilayer MoS<sub>2</sub> FETs showing ambipolar (i.e. both p- and n-type) current transport were fabricated by self-aligned deposition of source/drain contacts in the O<sub>2</sub> plasma functionalized areas, and their electrical behavior is discussed in terms of the peculiar current injection mechanisms in the oxygen functionalized MoS<sub>2</sub> surface.

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[3] F. Giannazzo, et al., Phys. Rev. B **92**, 081307(R) (2015).

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